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Texas Instruments
SN74ALS112AN

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Datasheet of SN74ALS112AN - IC JK TYPE NEG TRG DUAL 16DIP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### SN54ALS112A, SN74ALS112A DUAL J-K NEGATIVE-EDGE-TRIGGERED FLIP-FLOPS WITH CLEAR AND PRESET

SDAS199A - APRIL 1982 - REVISED DECEMBER 1994

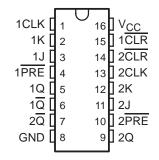
- Fully Buffered to Offer Maximum Isolation From External Disturbance
- Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

TYPE	TYPICAL MAXIMUM CLOCK FREQUENCY (MHz)	TYPICAL POWER DISSIPATION PER FLIP-FLOP (mW)
'ALS112A	50	6

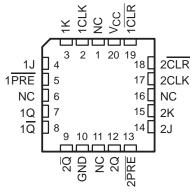
#### description

These devices contain two independent J-K negative-edge-triggered flip-flops. A low level at the preset (PRE) or clear (CLR) inputs sets or resets the outputs, regardless of the levels of the other inputs. When PRE and CLR are inactive (high), data at the J and K inputs meeting the setup-time requirements is transferred to the outputs on the negative-going edge of the clock pulse (CLK). Clock triggering occurs at a voltage level and is not directly related to the fall time of the clock pulse. Following the hold-time interval, data at the J and K inputs may be changed without affecting the levels at the outputs. These versatile flip-flops can perform as toggle flip-flops by tying J and K high.

#### SN54ALS112A . . . J PACKAGE SN74ALS112A . . . D OR N PACKAGE (TOP VIEW)



# SN54ALS112A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

The SN54ALS112A is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ALS112A is characterized for operation from 0°C to 70°C.

# FUNCTION TABLE (each flip-flop)

		OUTI	PUTS			
PRE	CLR	CLK	J	K	Q	Q
L	Н	Х	Χ	Х	Н	L
Н	L	X	Χ	X	L	Н
L	L	X	Χ	X	H <sup>†</sup>	H <sup>†</sup>
Н	Н	$\downarrow$	L	L	$Q_0$	$\overline{Q}_0$
Н	Н	$\downarrow$	Н	L	Н	L
Н	Н	$\downarrow$	L	Н	L	Н
Н	Н	$\downarrow$	Н	Н	Tog	gle
Н	Н	Н	Χ	Χ	$Q_0$	$\overline{Q}_0$

<sup>†</sup> The output levels in this configuration may not meet the minimum levels for V<sub>OH</sub>. Furthermore, this configuration is nonstable; that is, it does not persist when either PRE or CLR returns to its inactive (high) level.



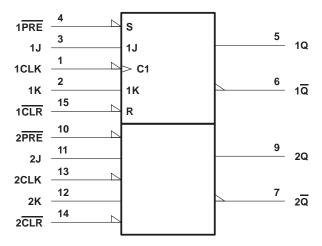
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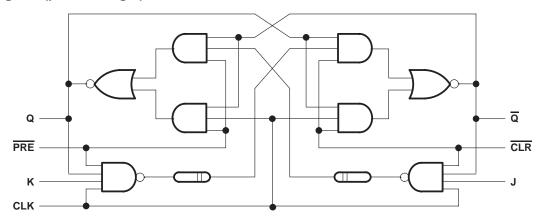
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#### logic symbol†



<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, and N packages.

#### logic diagram (positive logic)



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V <sub>CC</sub>		
Operating free-air temperature range, T <sub>A</sub> :		
	SN74ALS112A	 0°C to 70°C
Storage temperature range		-65°C to 150°C

<sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



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## SN54ALS112A, SN74ALS112A DUAL J-K NEGATIVE-EDGE-TRIGGERED FLIP-FLOPS WITH CLEAR AND PRESET

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#### recommended operating conditions

			SN54ALS112A		2A	SN7	UNIT		
			MIN	NOM	MAX	MIN	NOM	MAX	UNII
VCC	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage		2			2			V
V <sub>IL</sub>	Low-level input voltage				0.7			0.8	V
lOH	High-level output current				-0.4			-0.4	mA
lOL	Low-level output current				4			8	mA
fclock	Clock frequency		0		25	0		30	MHz
		PRE or CLR low	15			10			
t <sub>w</sub>	Pulse duration	CLK high	20			16.5			ns
		CLK low	20			16.5			
	0.161.101.1.1	Data	25			22			
t <sub>su</sub>	Setup time before CLK↓	PRE or CLR inactive	22			20			ns
t <sub>h</sub>	Hold time after CLK↓	Data	0			0			ns
TA	Operating free-air temperature		-55		125	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

_				SNS	4ALS11	2A	SN7	'4ALS11	2A	
P	ARAMETER	IESI Co	ONDITIONS	MIN	MIN TYPT MAX		MIN	TYP <sup>†</sup>	MAX	UNIT
٧ıK		V <sub>CC</sub> = 4.5 V,	I <sub>I</sub> = -18 mA			-1.5			-1.5	V
VOH		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V <sub>CC</sub> -2			V <sub>CC</sub> -2			V
M.		V 45V	I <sub>OL</sub> = 4 mA		0.25	0.4		0.25	0.4	.,
VOL		V <sub>CC</sub> = 4.5 V	$I_{OL} = 8 \text{ mA}$					0.35	0.5	V
	J, K, or CLK	V 55V				0.1			0.1	A
l <sub>l</sub>	PRE or CLR	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 7 V			0.2			0.2	mA
	J, K, or CLK					20			20	
lН	PRE or CLR	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 2.7 V			40			40	μΑ
	J, K, or CLK					-0.2			-0.2	_
ΊL	PRE or CLR	V <sub>CC</sub> = 5.5 V,	$V_{  } = 0.4 \text{ V}$			-0.4			-0.4	mA
lo‡	•	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.25 V	-20		-112	-30		-112	mA
ICC		V <sub>CC</sub> = 5.5 V,	See Note 1		2.5	4.5		2.5	4.5	mA

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .



<sup>‡</sup> The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, Ios. NOTE 1: Icc is measured with J, K, CLK, and PRE grounded, then with J, K, CLK, and CLR grounded.



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#### switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C <sub>L</sub> R <sub>I</sub>	$V_{CC}$ = 4.5 V to 5.5 V, $C_L$ = 50 pF, $R_L$ = 500 $\Omega$ , $T_A$ = MIN to MAX $^{\dagger}$			UNIT
	, ,	SN54ALS112A SN74ALS112A					
			MIN	MAX	MIN	MAX	
f <sub>max</sub>			25		30		MHz
<sup>t</sup> PLH	DDE as OLD	Q or Q	3	26	3	15	
<sup>t</sup> PHL	PRE or CLR	Q or Q	4	23	4	18	ns
<sup>t</sup> PLH	CLK	Q or Q	3	23	3	15	ns
<sup>t</sup> PHL	OLK	વળ વ	5	24	5	19	115

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

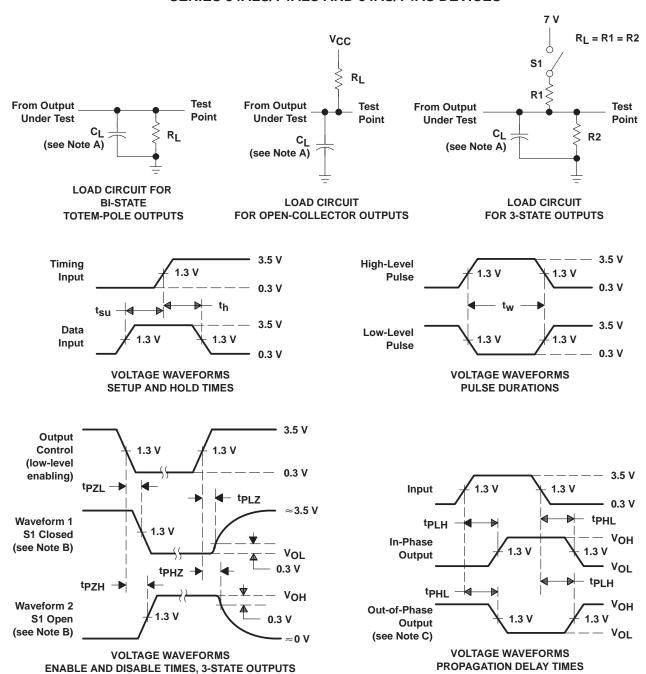
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## SN54ALS112A, SN74ALS112A DUAL J-K NEGATIVE-EDGE-TRIGGERED FLIP-FLOPS WITH CLEAR AND PRESET

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# PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR  $\leq$  1 MHz,  $t_{\Gamma}$  =  $t_{f}$  = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms





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PACKAGE OPTION ADDENDUM

17-Dec-2015

#### PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
8400002EA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	8400002EA SNJ54ALS112AJ	Samples
8400002FA	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI	-55 to 125		
JM38510/37103B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 37103B2A	Samples
JM38510/37103BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 37103BEA	Samples
M38510/37103B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 37103B2A	Samples
M38510/37103BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 37103BEA	Samples
SN54ALS112AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54ALS112AJ	Samples
SN74ALS112AD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS112A	Samples
SN74ALS112ADR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS112A	Samples
SN74ALS112AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS112AN	Samples
SN74ALS112AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70		
SN74ALS112ANSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS112A	Samples
SNJ54ALS112AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	8400002EA SNJ54ALS112AJ	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability

information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

Addendum-Page 1



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PACKAGE OPTION ADDENDUM

17-Dec-2015

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green\* to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54ALS112A, SN74ALS112A:

- Catalog: SN74ALS112A
- Military: SN54ALS112A

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

Addendum-Page 2

Datasheet of SN74ALS112AN - IC JK TYPE NEG TRG DUAL 16DIP

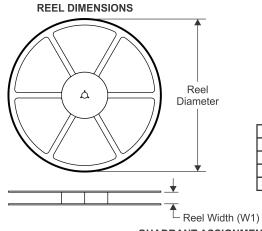
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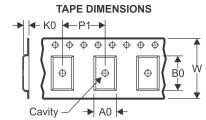


### PACKAGE MATERIALS INFORMATION

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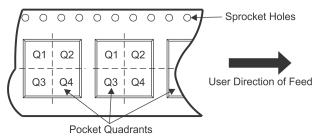
#### TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS112ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74ALS112ANSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

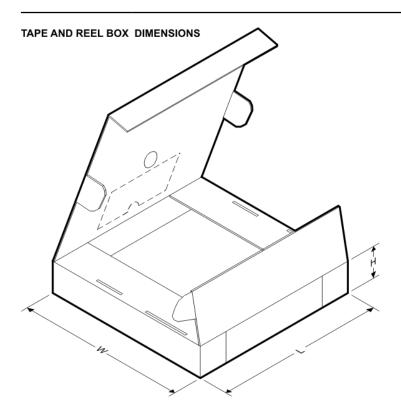
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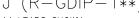


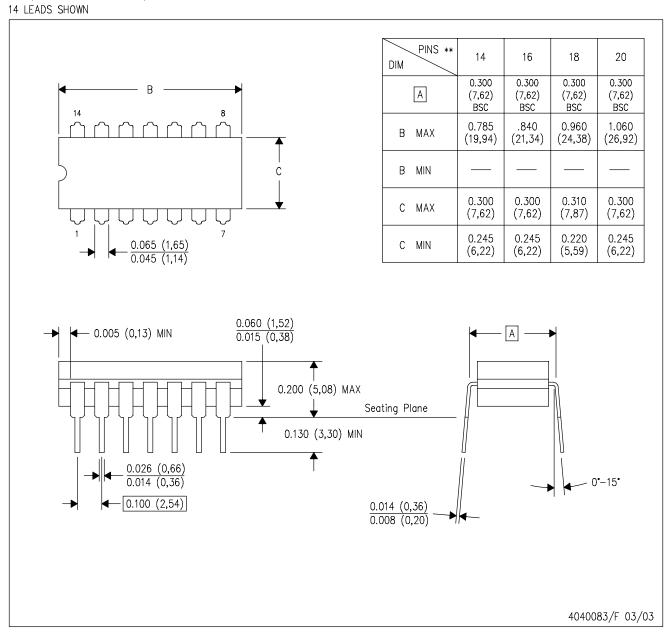
#### \*All dimensions are nominal

7 til dilliononono di o momina							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS112ADR	SOIC	D	16	2500	333.2	345.9	28.6
SN74ALS112ANSR	SO	NS	16	2000	367.0	367.0	38.0

## J (R-GDIP-T\*\*)

### CERAMIC DUAL IN-LINE PACKAGE





- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

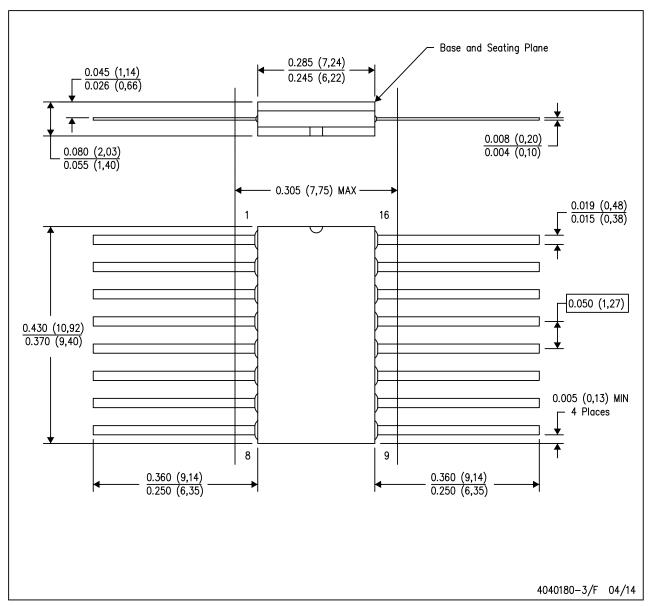




#### **MECHANICAL DATA**

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP2-F16

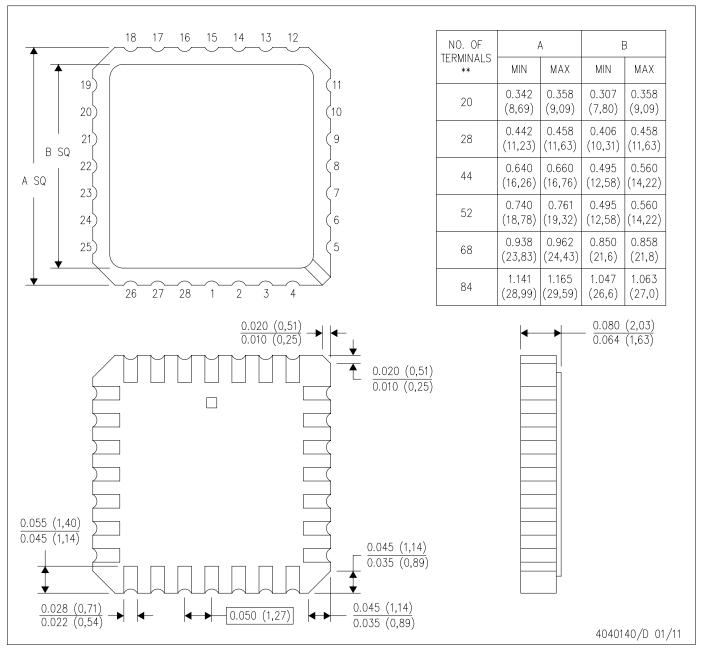


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## FK (S-CQCC-N\*\*)

#### LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004





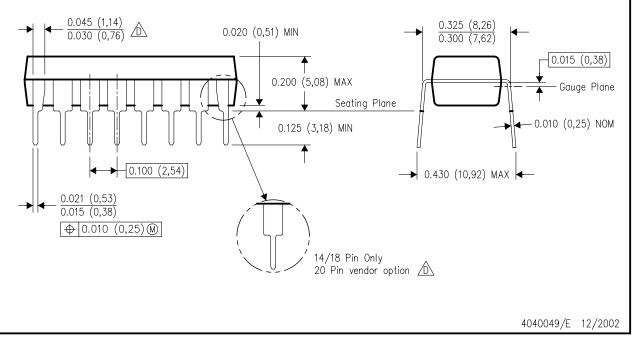
16 PINS SHOWN

#### **MECHANICAL DATA**

## N (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

DIM	NS **	16	18	20
A MA	X 0.775 (19,69		0.920 (23,37)	1.060 (26,92)
A MI	0.745 (18,92		0.850 (21,59)	0.940 (23,88)
MS-0 VARIAT	Ι ΔΔ	ВВ	AC	AD



 $\triangle$ 

- . All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.

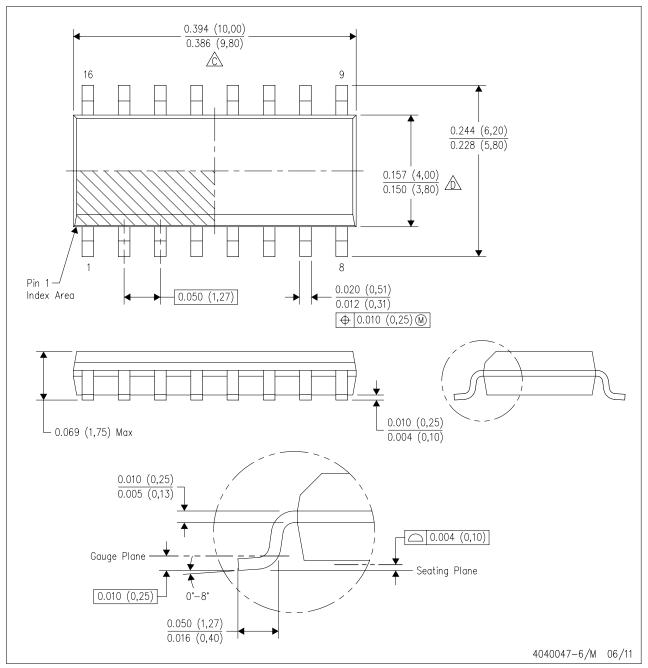




#### **MECHANICAL DATA**

## D (R-PDSO-G16)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.

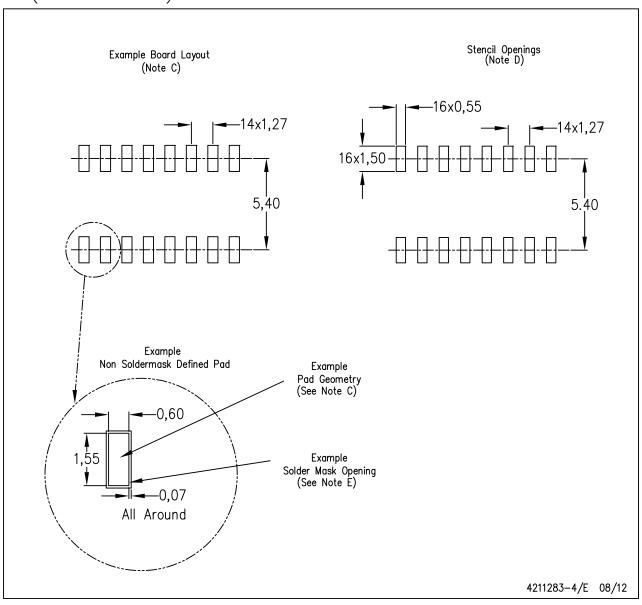




#### LAND PATTERN DATA

## D (R-PDSO-G16)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



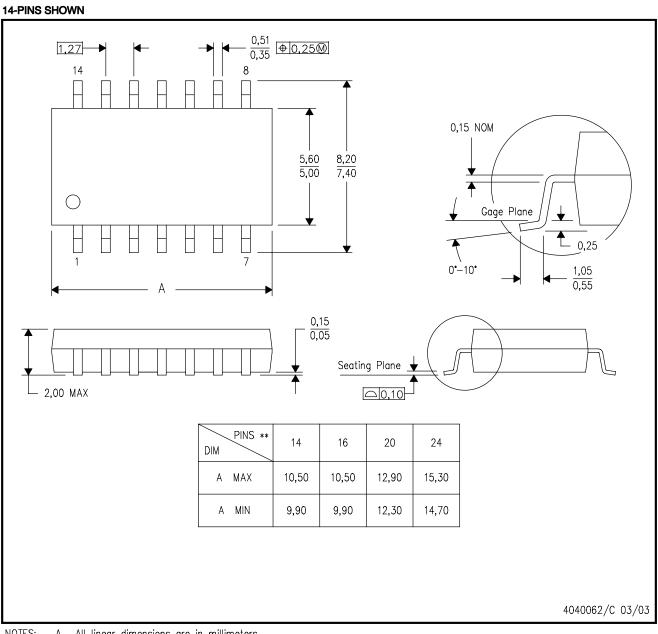


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#### **MECHANICAL DATA**

#### NS (R-PDSO-G\*\*)

# PLASTIC SMALL-OUTLINE PACKAGE



- All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.





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